

TOSHIBA GTR Module Silicon N Channel IGBT

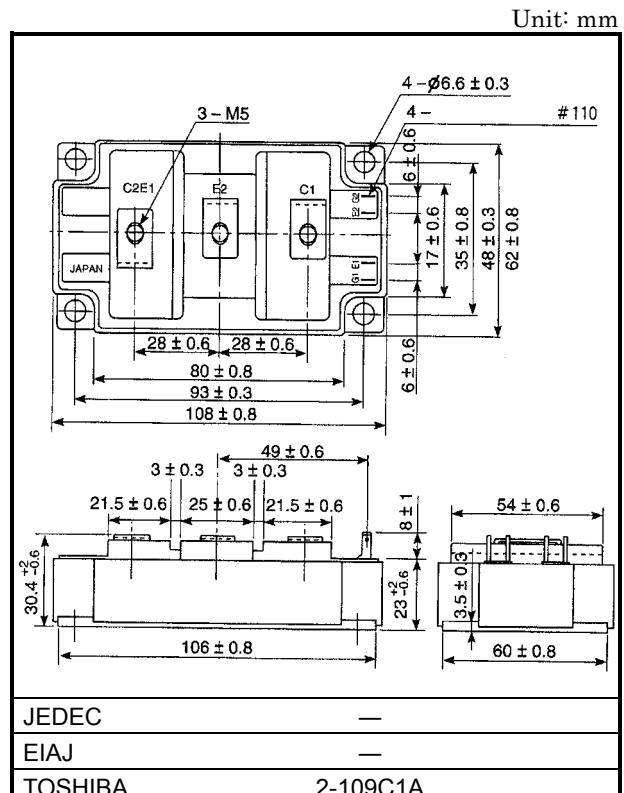
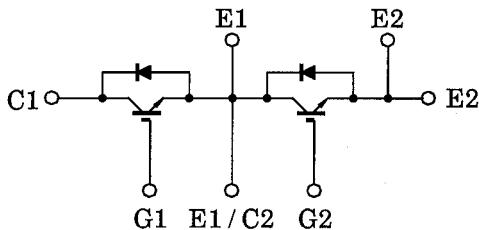
# MG300Q2YS50

High Power Switching Applications

Motor Control Applications

- High input impedance
- High speed :  $t_f = 0.3\mu s$  (Max.)  
Inductive load
- Low saturation voltage  
 $: V_{CE}(\text{sat}) = 3.6V$  (Max.)
- Enhancement-mode
- Includes a complete half bridge in one package.
- The electrodes are isolated from case.

## Equivalent Circuit



## Maximum Ratings (Ta = 25°C)

| Characteristic                          |     | Symbol                           | Rating                | Unit |
|---|-----|----------------------------------|-----------------------|------|
| Collector-emitter voltage               |     | V <sub>CES</sub>                 | 1200                  | V    |
| Gate-emitter voltage                    |     | V <sub>GES</sub>                 | ±20                   | V    |
| Collector current                       | DC  | I <sub>C</sub><br>(25°C / 80°C)  | 400 / 300             | A    |
|   | 1ms | I <sub>CP</sub><br>(25°C / 80°C) | 800 / 600             |      |
| Forward current                         | DC  | I <sub>F</sub>                   | 300                   | A    |
|   | 1ms | I <sub>FM</sub>                  | 600                   |      |
| Collector power dissipation (Tc = 25°C) |     | P <sub>C</sub>                   | 2000                  | W    |
| Junction temperature                    |     | T <sub>j</sub>                   | 150                   | °C   |
| Storage temperature range               |     | T <sub>stg</sub>                 | -40 ~ 125             | °C   |
| Isolation voltage                       |     | V <sub>Isol</sub>                | 2500<br>(AC 1 minute) | V    |
| Screw torque (Terminal / mounting)      |     | —                                | 3 / 3                 | N·m  |

## Electrical Characteristics (Ta = 25°C)

| Characteristic                       |                     | Symbol                | Test Condition   | Min                    | Typ. | Max  | Unit   |
|--------------------------------------|---------------------|-----------------------|--|------------------------|------|------|--------|
| Gate leakage current                 |                     | I <sub>GES</sub>      | V <sub>GE</sub> = ±20V, V <sub>CE</sub> = 0  | —                      | —    | ±500 | nA     |
| Collector cut-off current            |                     | I <sub>CES</sub>      | V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0   | —                      | —    | 1.0  | mA     |
| Gate-emitter cut-off voltage         |                     | V <sub>GE</sub> (OFF) | I <sub>C</sub> = 300mA, V <sub>CE</sub> = 5V   | 3.0                    | —    | 6.0  | V      |
| Collector-emitter saturation voltage |                     | V <sub>CE</sub> (sat) | I <sub>C</sub> = 300A,<br>V <sub>GE</sub> = 15V  | T <sub>j</sub> = 25°C  | —    | 2.8  | 3.6    |
|                                      |                     |                       |  | T <sub>j</sub> = 125°C | —    | 3.1  | 4.0    |
| Input capacitance                    |                     | C <sub>ies</sub>      | V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0, f = 1MHz   | —                      | 30.0 | —    | nF     |
| Switching time                       | Turn-on delay time  | t <sub>d</sub> (on)   | Inductive load<br>V <sub>CC</sub> = 600V<br>I <sub>C</sub> = 300A<br>V <sub>GE</sub> = ±15V<br>R <sub>G</sub> = 2.7Ω<br>(Note 1) | —                      | 0.05 | —    | μs     |
|                                      | Rise time           | t <sub>r</sub>        |  | —                      | 0.05 | —    |        |
|                                      | Turn-on time        | t <sub>on</sub>       |  | —                      | 0.2  | —    |        |
|                                      | Turn-off delay time | t <sub>d</sub> (off)  |  | —                      | 0.5  | —    |        |
|                                      | Fall time           | t <sub>f</sub>        |  | —                      | 0.1  | 0.3  |        |
|                                      | Turn-off time       | t <sub>off</sub>      |  | —                      | 0.6  | —    |        |
| Forward voltage                      |                     | V <sub>F</sub>        | I <sub>F</sub> = 300 A, V <sub>GE</sub> = 0  | —                      | 2.4  | 3.5  | V      |
| Reverse recovery time                |                     | t <sub>rr</sub>       | I <sub>F</sub> = 300 A, V <sub>GE</sub> = -10 V,<br>di / dt = 1000 A / μs<br>(Note 1)  | —                      | 0.2  | 0.3  | μs     |
| Thermal resistance                   |                     | R <sub>th</sub> (j-c) | Transistor stage   |                        | —    | 0.06 | °C / W |
|                                      |                     |                       | Diode stage  |                        | —    | 0.19 |        |